BT151 series L and R Thyristors

Rev. 04 — 23 October 2006

Product data sheet

High bidirectional blocking voltage

Static switching

I_{T(RMS)} ≤ 12 A

I_{T(AV)} \leq 7.5 A

SOT78 (3-lead TO-220AB)

Protection circuits

I_{TSM} \leq 120 A (t = 10 ms)

I_{GT} \leq 5 mA (BT151 series L)

I_{GT} \leq 15 mA (BT151 series R)

1. Product profile

1.1 General description

Passivated thyristors in a SOT78 plastic package.

1.2 Features

High thermal cycling performance

1.3 Applications

- Motor control
- Ignition circuits

1.4 Quick reference data

- V_{DRM} ≤ 500 V (BT151-500L/R)
- V_{RRM} ≤ 500 V (BT151-500L/R)
- V_{DRM} ≤ 650 V (BT151-650L/R)
- V_{RRM} ≤ 650 V (BT151-650L/R)
- $V_{DRM} \le 800 \text{ V} (BT151-800R)$
- V_{RRM} ≤ 800 V (BT151-800R)

2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outline	Symbol
1	cathode (K)		N 1
2	anode (A)	mb	А 🕂 К
3	gate (G)	۲ 🔾 ۲	G sym037
mb	mounting base; connected to anode		



3. Ordering information

Type number	Package	Package								
	Name	Description	Version							
BT151-500L	SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole;	SOT78							
BT151-500R		3-lead TO-220AB								
BT151-650L										
BT151-650R										
BT151-800R										

4. Limiting values

Table 3. Limiting values

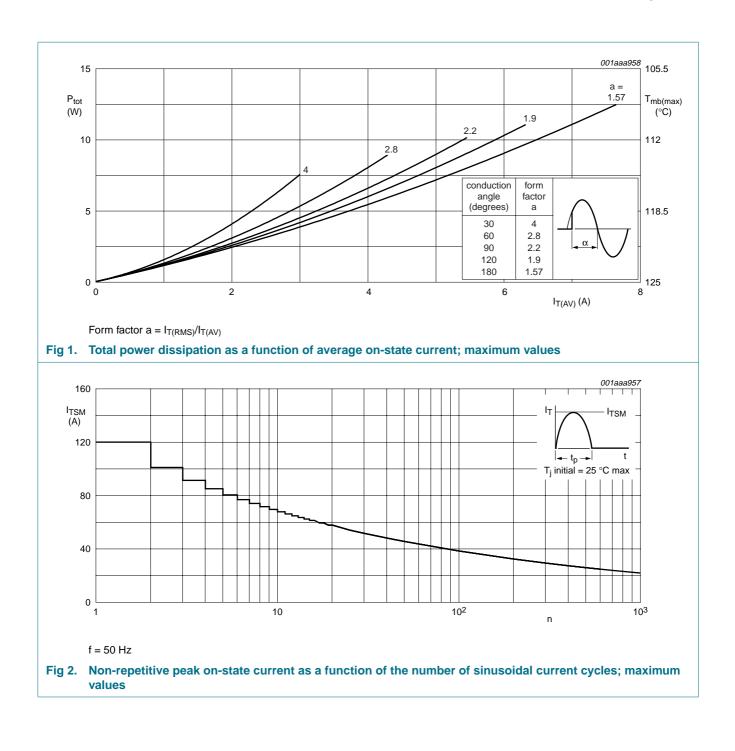
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage	BT151-500L; BT151-500R	[1]	-	500	V
		BT151-650L; BT151-650R	[1]	-	650	V
		BT151-800R		-	800	V
V _{RRM}	repetitive peak reverse voltage	BT151-500L; BT151-500R	[1]	-	500	V
		BT151-650L; BT151-650R	[1]	-	650	V
		BT151-800R		-	800	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 109 °C; see <u>Figure 1</u>		-	7.5	А
I _{T(RMS)}	RMS on-state current	all conduction angles; see $\frac{\text{Figure 4}}{\text{and 5}}$		-	12	А
	non-repetitive peak on-state current	half sine wave; $T_j = 25 \text{ °C}$ prior to surge; see Figure 2 and 3				
		t = 10 ms		-	120	А
		t = 8.3 ms		-	132	А
l ² t	I ² t for fusing	t = 10 ms		-	72	A ² s
dl _T /dt	rate of rise of on-state current	I_{TM} = 20 A; I_G = 50 mA; dI _G /dt = 50 mA/µs		-	50	A/μs
I _{GM}	peak gate current			-	2	А
V _{RGM}	peak reverse gate voltage			-	5	V
P _{GM}	peak gate power			-	5	W
P _{G(AV)}	average gate power	over any 20 ms period		-	0.5	W
T _{stg}	storage temperature			-40	+150	°C
Tj	junction temperature			-	125	°C

 Although not recommended, off-state voltages up to 800 V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.

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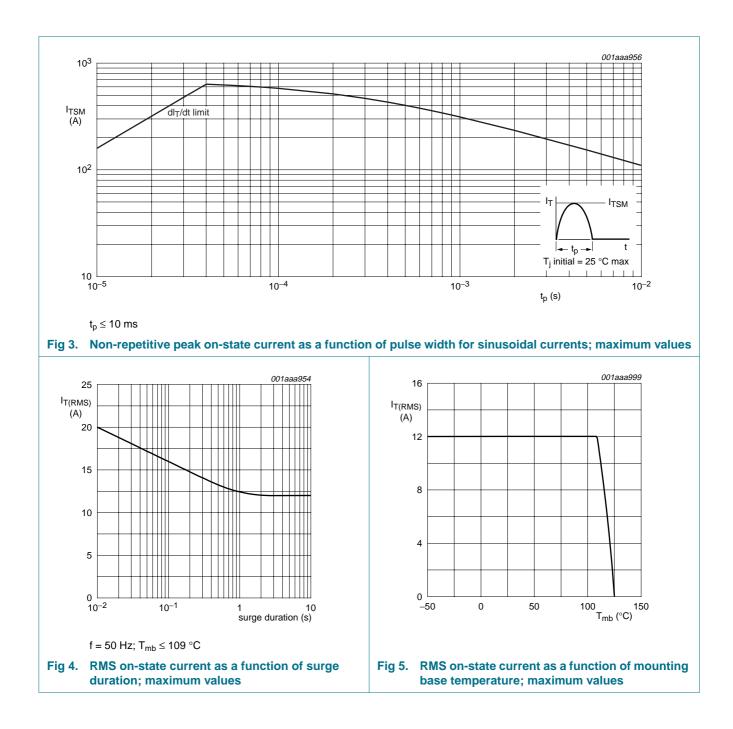
Thyristors



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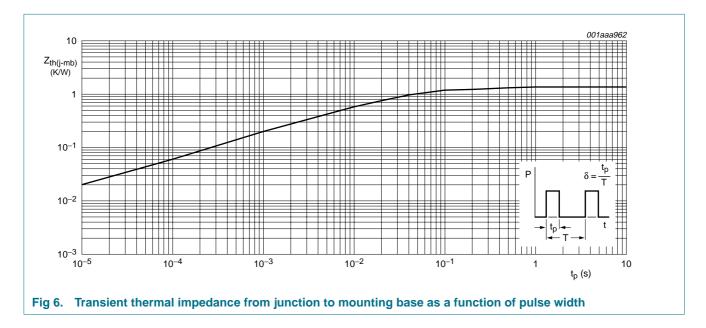


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Thyristors

Thermal characteristics 5.

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	see Figure 6	-	-	1.3	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	60	-	K/W



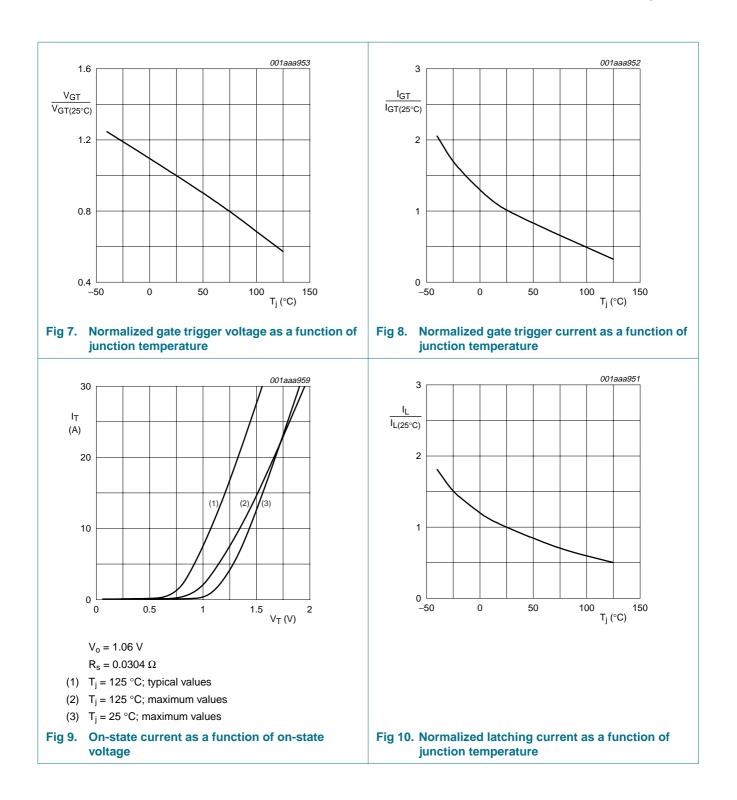
Thyristors

6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; \text{ I}_T = 100 \text{ mA}; \text{ see } \frac{\text{Figure 8}}{100 \text{ mA}}$				
		BT151-500L	-	2	5	mA
		BT151-500R	-	2	15	mA
		BT151-650L	-	2	5	mA
		BT151-650R	-	2	15	mA
		BT151-800R	-	2	15	mA
IL	latching current	V _D = 12 V; I _{GT} = 100 mA; see <u>Figure 10</u>	-	10	40	mA
Ι _Η	holding current	V _D = 12 V; I _{GT} = 100 mA; see <u>Figure 11</u>	-	7	20	mA
V _T	on-state voltage	I _T = 23 A; see <u>Figure 9</u>	-	1.4	1.75	V
V _{GT}	gate trigger voltage	I_T = 100 mA; V_D = 12 V; see <u>Figure 7</u>	-	0.6	1.5	V
		$ I_T = 100 \text{ mA}; V_D = V_{DRM(max)}; $	0.25	0.4	-	V
I _D	off-state current	$V_D = V_{DRM(max)}; T_j = 125 \ ^{\circ}C$	-	0.1	0.5	mA
I _R	reverse current	$V_R = V_{RRM(max)}; T_j = 125 \ ^{\circ}C$	-	0.1	0.5	mA
Dynamic o	haracteristics					
dV _D /dt rate of rise of off-state voltage		$V_{DM} = 0.67 \times V_{DRM(max)}$; $T_j = 125 \text{ °C}$; exponential waveform; see Figure 12				
		R _{GK} = 100 Ω	200	1000	-	V/μs
		gate open circuit	50	130	-	V/μs
lgt	gate-controlled turn-on time	$I_{TM} = 40 \text{ A}; V_D = V_{DRM(max)};$ $I_G = 100 \text{ mA}; \text{dI}_G/\text{dt} = 5 \text{ A}/\mu\text{s}$	-	2	-	μs
q	commutated turn-off time		-	70	-	μs

BT151 series L and R

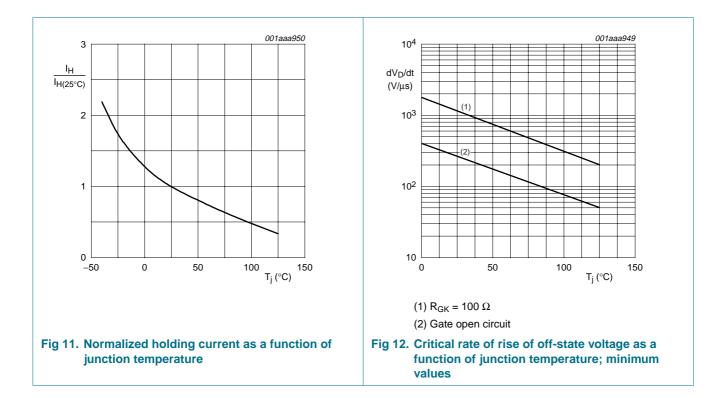
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7. Package outline

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mm	4.7 4.1	1.40 1.25	0.9 0.6	1.45 1.00	0.7 0.4	16.0 15.2	6.6 5.9	10.3 9.7	2.54	15.0 12.8	3.30 2.79	3.0	3.8 3.5	3.0 2.7	2.6 2.2	
ou	4.1 TLINE		0.6	1.00		15.2	5.9	9.7	2.54	12.8	2.79	3.0	3.5 EUR	2.7 OPEAN	2.2	ISSUE DATE
VERSION SOT78			IE	C		JEDEC		JE	ITA				PROJ	JECTION	4	
														30		05-03-22

Fig 13. Package outline SOT78 (TO-220AB)

BT151_SER_L_R_4
Product data sheet

Thyristors

8. Revision history

Table 6. Revision his	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BT151_SER_L_R_4	20061023	Product data sheet	-	BT151_SERIES_3
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply v	vith the new identity
	 Legal texts 	have been adapted to the n	ew company name whe	ere appropriate.
	 Added type 	numbers BT151-500L and	BT151-650L	
BT151_SERIES_3 (9397 750 13159)	20040607	Product specification	-	BT151_SERIES_2
BT151_SERIES_2	19990601	Product specification	-	BT151_SERIES_1
BT151_SERIES_1	19970901	Product specification	-	-

9. Legal information

9.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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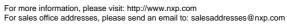
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